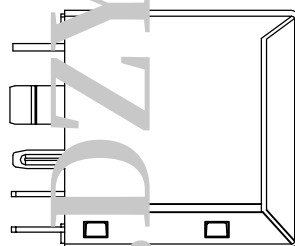
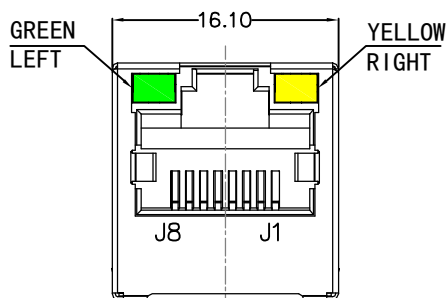


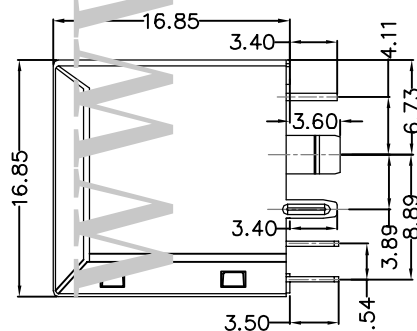
TOP VIEW



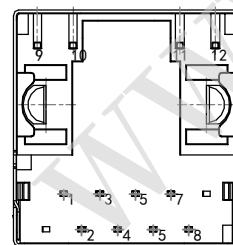
LEFT SIDE VIEW



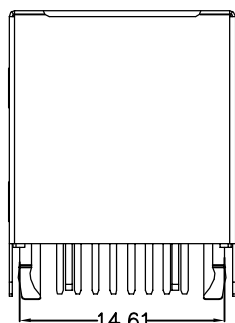
FRONT VIEW



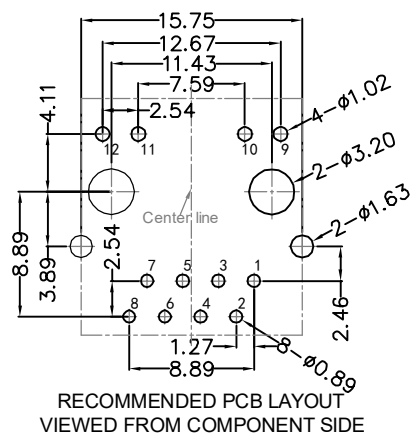
RIGHT SIDE VIEW



BACK VIEW



BOTTOM VIEW

RECOMMENDED PCB LAYOUT
VIEWED FROM COMPONENT SIDE**MATERIAL:**

HOUSING: PBT,UL94V-0,BLACK.

TERMINALS BRACKET: PBT,UL94V-0,BLACK.

SHIELD: C2680,T=0.20MM,NICKEL PLATING ON ALL AREA.

TERMINAL: PHOSPHOR BRONZE C5210,T=0.35MM,
6U" GOLD PLATING ON CONTACT AREA.**MECHANICAL:**

DURABILITY: 750 CYCLES MIN.

MATING FORCE: 23N MAX.

OPERATING TEMPERATURE: -40°C~+85°C.

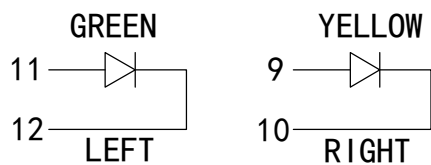
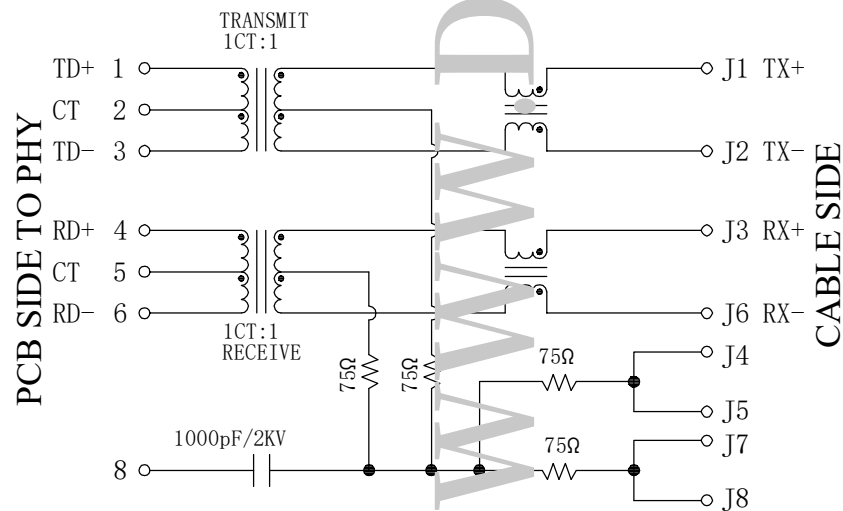
STORAGE TEMPERATURE: -40°C~+85°C.

ALL CRITICAL DIMENSIONS WITH "*"



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TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.* ±2* X.X* ±0.5*	DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: RJ45 180 ° DIP 带灯100BASE	
	CHECKED BY: 马跃	DATE : 2014-02-23	PART NO.	HYC224-RJ45-168
 UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY: 邱国夷	DATE : 2014-02-23	MOLD NO.	
			DRAW NO:	HYC-RJ18022016
			SHEET NO.	1 OF 1



Electrical:

- 1.Turn ratio:1~3:J1~J2=1CT:1CT(±2%).
4~6:J3~J6=1CT:1CT(±2%).
- 2.OCL:350uH Min.at 100KHz 100mV 8mA DC.
- 3.Insertion Loss: -1.0 dB Max 1~100MHz.
- 4.Return loss: -20dB Min 1~10MHz;
-16dB Min 10~30MHz.
-12dB Min 30~60MHz.
-10dB Min 60~80MHz.
- 5.Cross talk: -40dB Min 1~30MHz;
-35dB Min 30~60MHz;
-30dB Min 60~100MHz;
- 6.CMR: -30dB Min 1~100MHz;
- 7.Hi-Pot:1500V AC & 2250V DC
6S 1mA PRI TO SEC

LED Specification

Standard LED Color	LED Wavelength	Foward(A)	Foward(V)
Green	568nm	20mA	1.85-2.45V
Yellow	585nm	20mA	1.7-2.2V



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TOLERANCE:

X.X ±0.30

X.XX ±0.25

X.XXX ±0.15

X' ±2" X.X' ±0.5"

UNIT: mm [inch]

SCALE:1:1

SIZE: A4

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PART NAME:

RJ45 180 ° DIP 带灯100BASE

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马跃

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2014-02-23

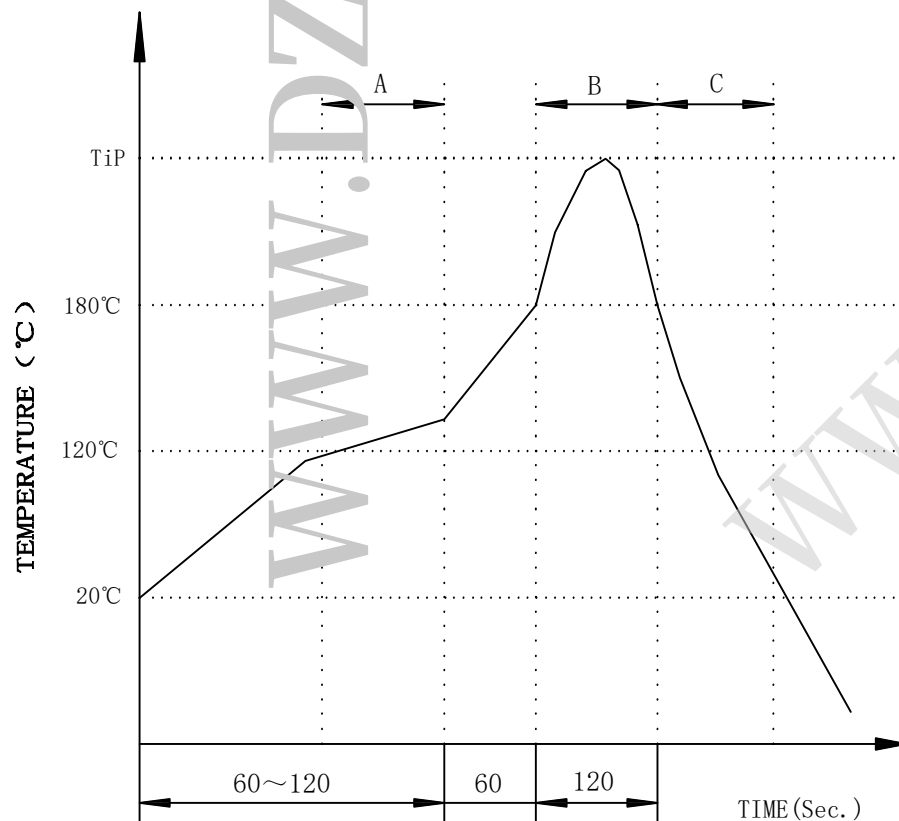
DRAW NO:

HYC-RJ18022016

SHEET NO.

1 OF 1

PROFILE OF WAVE SOLDER



A.Preheating B.Soldering C.Gradual Cooling

Tip temperature:260±5°C.

Tip temperature time:5Sec Max.

Tip melting point of Sn96.5/Ag3/Cu0.5:217°C.

Remarks: after wave soldering, the plastic positioning columns of the product which under the PCB will be slightly melted, but it won't affect its function.



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X.X ±0.30

X.XX ±0.25

X.XXX ±0.15

X.' ±2' X.X' ±0.5'



UNIT: mm [inch]

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